

74ALVCH16841

20-bit bus interface D-type latch; 3-state

Rev. 3 — 12 September 2018

Product data sheet

1. General description

The 74ALVCH16841 has two 10-bit D-type latch featuring separate D-type inputs for each latch and 3-state outputs for bus oriented applications. The two sections of each register are controlled independently by the latch enable (nLE) and output enable (nOE) control gates.

When nOE is LOW, the data in the registers appears at the outputs. When nOE is HIGH the outputs are in High-impedance OFF state. Operation of the nOE input does not affect the state of the flip-flops.

The 74ALVCH16841 has active bus hold circuitry which is provided to hold unused or floating data inputs at a valid logic level. This feature eliminates the need for external pull-up or pull-down resistors.

2. Features and benefits

- Wide supply voltage range of 1.2 V to 3.6 V
- CMOS low power consumption
- Direct interface with TTL levels
- Current drive ± 24 mA at $V_{CC} = 3.0$ V
- MULTIBYTE flow-through standard pin-out architecture
- Low inductance multiple V_{CC} and GND pins for minimize noise and ground bounce
- All data inputs have bushold
- Output drive capability 50 Ω transmission lines at 85 °C
- 3-state non-inverting outputs for bus oriented applications
- Complies with JEDEC standards:
 - JESD8-5 (2.3 V to 2.7 V)
 - JESD8B/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM ANSI/ESDA/JEDEC JS-001 exceeds 2000 V
 - CDM JESD22-C101E exceeds 1000 V

3. Ordering information

Table 1. Ordering information

| Type number | Package | | | Version |
|-----------------|-------------------|---------|--|----------|
| | Temperature range | Name | Description | |
| 74ALVCH16841DGG | -40 °C to +85 °C | TSSOP56 | plastic thin shrink small outline package; 56 leads; body width 6.1 mm | SOT364-1 |

4. Functional diagram

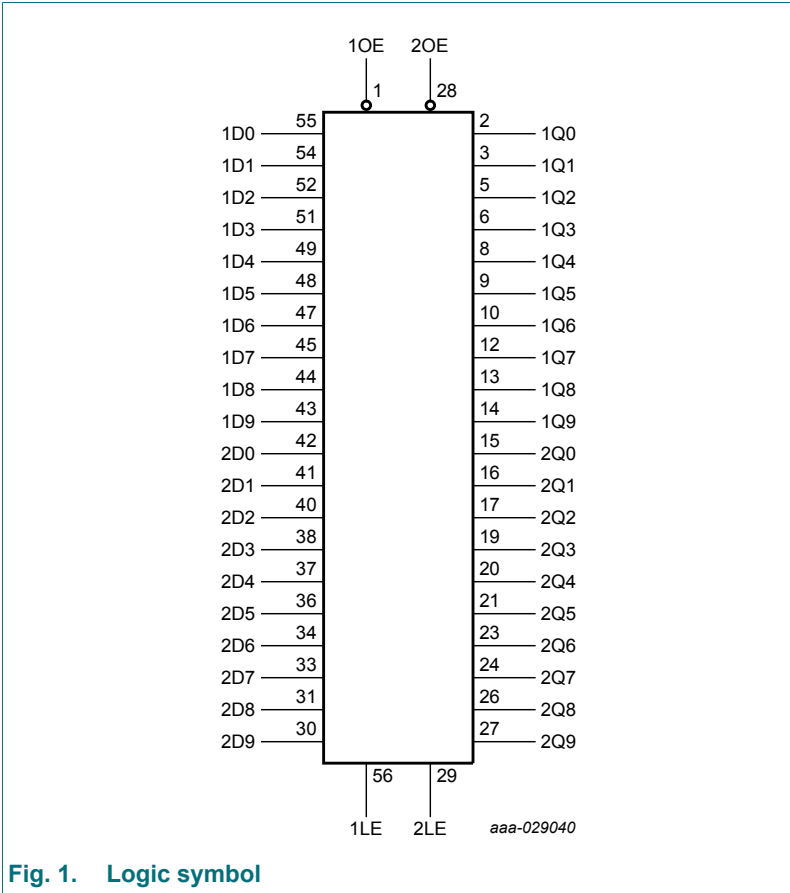


Fig. 1. Logic symbol

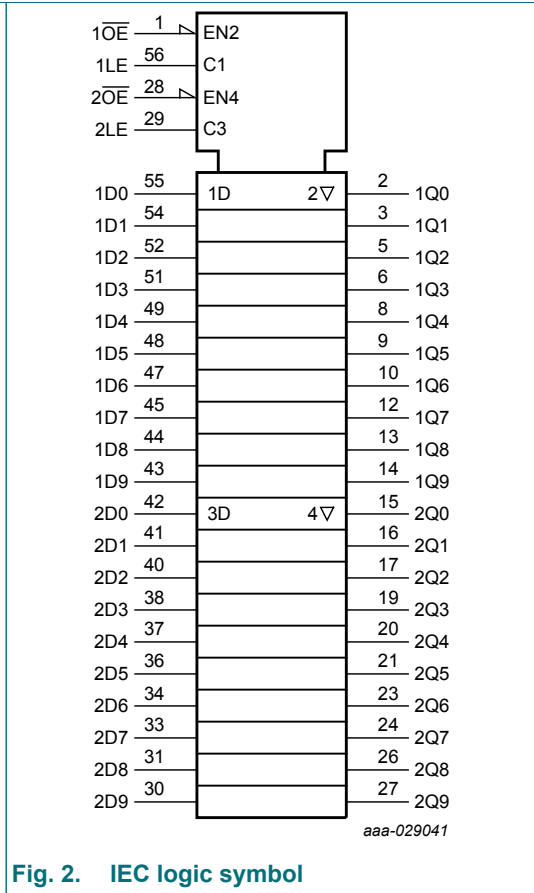


Fig. 2. IEC logic symbol

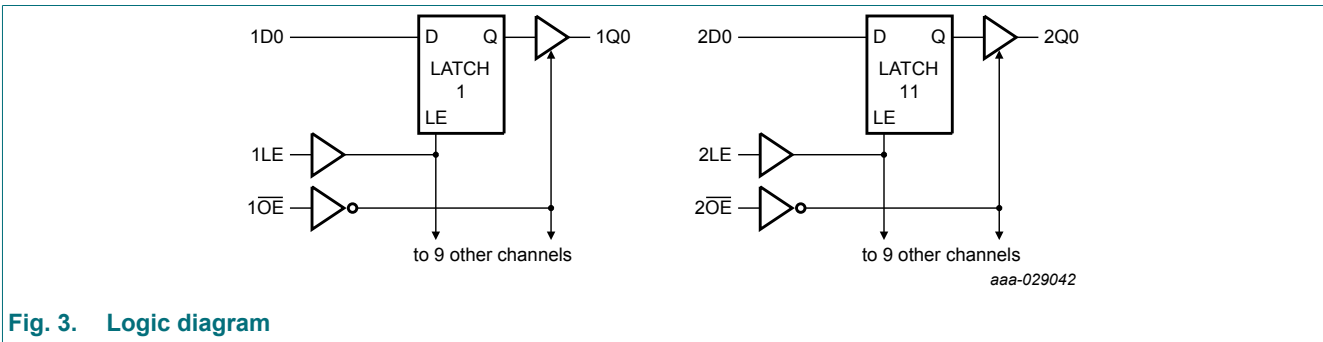


Fig. 3. Logic diagram

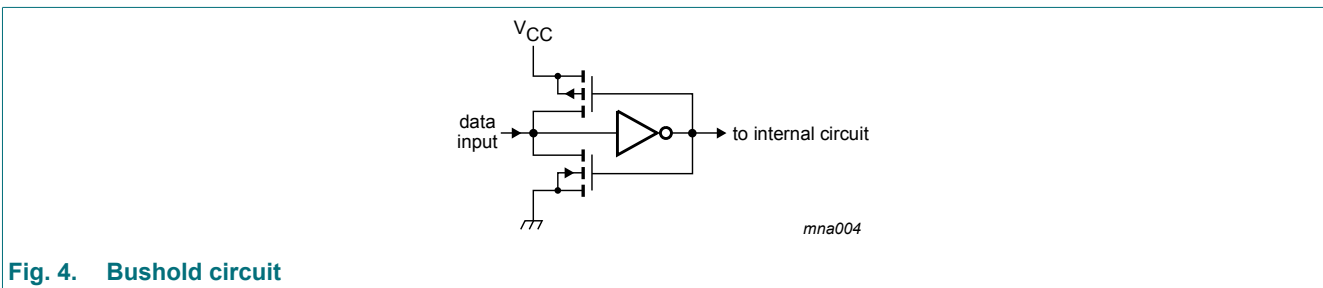


Fig. 4. Bushold circuit

5. Pinning information

5.1. Pinning

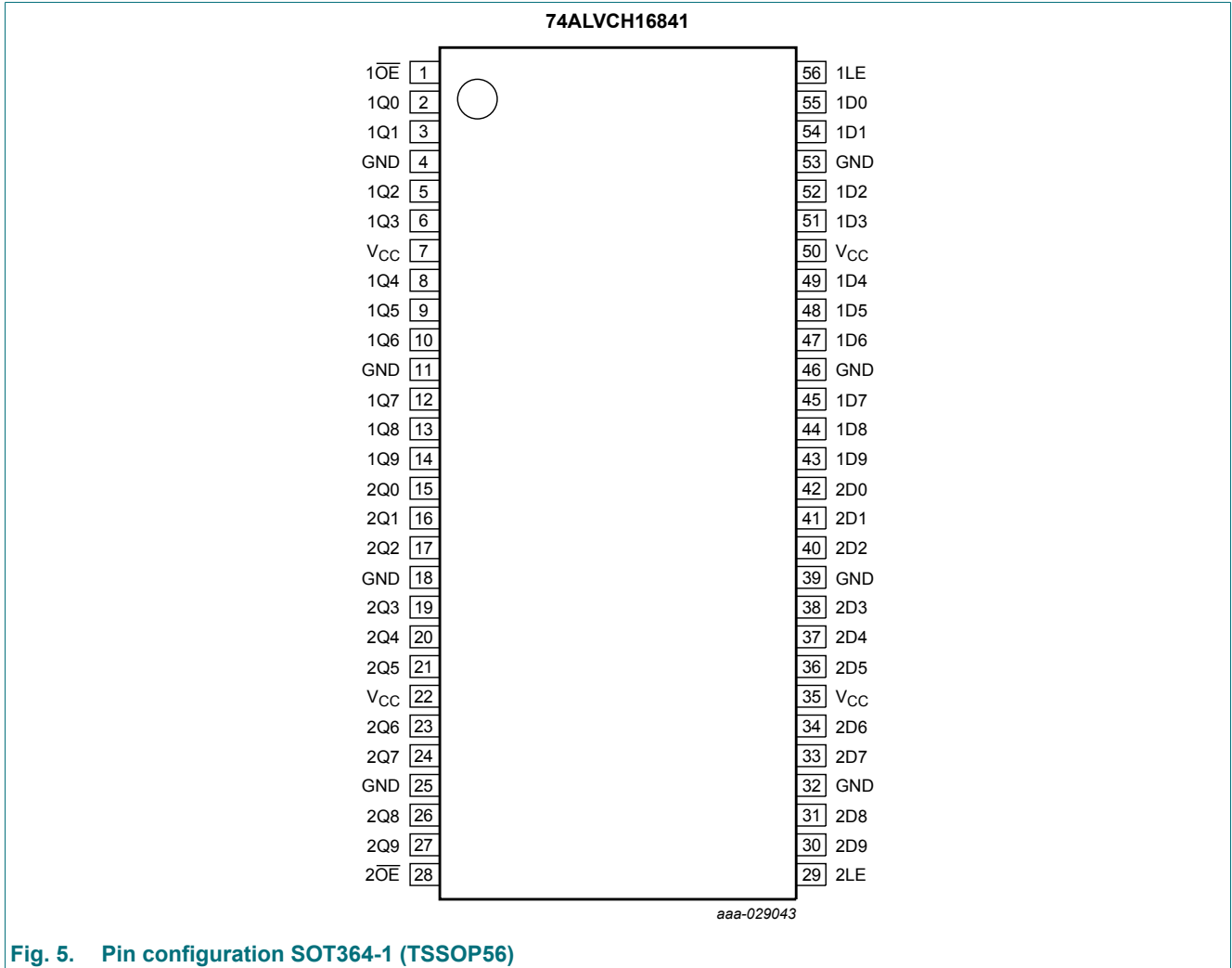


Fig. 5. Pin configuration SOT364-1 (TSSOP56)

5.2. Pin description

Table 2. Pin description

| Symbol | Pin | Description |
|--|--|-----------------------------------|
| 1D0, 1D1, 1D2, 1D3, 1D4, 1D5, 1D6, 1D7, 1D8, 1D9 | 55, 54, 52, 51, 49, 48, 47, 45, 44, 43 | data input |
| 2D0, 2D1, 2D2, 2D3, 2D4, 2D5, 2D6, 2D7, 2D8, 2D9 | 42, 41, 40, 38, 37, 36, 34, 33, 31, 30 | data input |
| 1Q0, 1Q1, 1Q2, 1Q3, 1Q4, 1Q5, 1Q6, 1Q7, 1Q8, 1Q9 | 2, 3, 5, 6, 8, 9, 10, 12, 13, 14 | data output |
| 2Q0, 2Q1, 2Q2, 2Q3, 2Q4, 2Q5, 2Q6, 2Q7, 2Q8, 2Q9 | 15, 16, 17, 19, 20, 21, 23, 24, 26, 27 | data output |
| 1OE, 2OE | 1, 28 | output enable inputs (active-LOW) |
| 1LE, 2LE | 56, 29 | latch enable inputs |
| GND | 4, 11, 18, 25, 32, 39, 46, 53 | ground (0 V) |
| V _{CC} | 7, 22, 35, 50 | supply voltage |

6. Functional description

Table 3. Function table

H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

| Inputs | | | Outputs |
|--------|-----|-----|----------------|
| nOE | nLE | nDn | nQn |
| L | H | L | L |
| L | H | H | H |
| L | L | X | Q ₀ |
| H | X | X | Z |

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------|--|------|-----------------------|------|
| V _{CC} | supply voltage | | -0.5 | +4.6 | V |
| V _I | input voltage | For control pins [1] | -0.5 | +4.6 | V |
| | | For data inputs [1] | -0.5 | V _{CC} + 0.5 | V |
| V _O | output voltage | [1] | -0.5 | V _{CC} + 0.5 | V |
| I _{IK} | input clamping current | V _I < 0 V | -50 | - | mA |
| I _{OK} | output clamping current | V _O > V _{CC} or V _O < 0 V | - | ±50 | mA |
| I _O | output current | V _O = 0 V to V _{CC} | - | ±50 | mA |
| I _{CC} | supply current | | - | 100 | mA |
| I _{GND} | ground current | | -100 | - | mA |
| T _{stg} | storage temperature | | -65 | +150 | °C |
| P _{tot} | total power dissipation | T _{amb} = -40 °C to +85 °C [2] | - | 600 | mW |

[1] The input and output voltage ratings may be exceeded if the input and output current ratings are observed.

[2] Above 55 °C the value of P_{tot} derates linearly with 8 mW/K.

8. Recommended operating conditions

Table 5. Recommended operating conditions

| Symbol | Parameter | Conditions | Min | Max | Unit |
|------------------|-------------------------------------|--|-----|-----------------|------|
| V _{CC} | supply voltage | for maximum speed performance; 30 pF output load | 2.3 | 2.7 | V |
| | | for maximum speed performance; 50 pF output load | 3.0 | 3.6 | V |
| V _I | input voltage | | 0 | V _{CC} | V |
| V _O | output voltage | | 0 | V _{CC} | V |
| T _{amb} | ambient temperature | in free air | -40 | +85 | °C |
| Δt/ΔV | input transition rise and fall rate | V _{CC} = 2.3 V to 3.0 V | - | 20 | ns/V |
| | | V _{CC} = 3.0 V to 3.6 V | - | 10 | ns/V |

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V). $T_{amb} = -40\text{ °C}$ to $+85\text{ °C}$

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|-----------------|---------------------------------|--|----------------|-----------------|------|---------------|
| V_{IH} | HIGH-level input voltage | $V_{CC} = 2.3\text{ V}$ to 2.7 V | 1.7 | 1.2 | - | V |
| | | $V_{CC} = 2.7\text{ V}$ to 3.6 V | 2.0 | 1.5 | - | V |
| V_{IL} | LOW-level input voltage | $V_{CC} = 2.3\text{ V}$ to 2.7 V | - | 1.2 | 0.7 | V |
| | | $V_{CC} = 2.7\text{ V}$ to 3.6 V | - | 1.5 | 0.8 | V |
| V_{OH} | HIGH-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = -100\text{ }\mu\text{A}$; $V_{CC} = 2.3\text{ V}$ to 3.6 V | $V_{CC} - 0.2$ | V_{CC} | - | V |
| | | $I_O = -6\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | $V_{CC} - 0.3$ | $V_{CC} - 0.08$ | - | V |
| | | $I_O = -12\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | $V_{CC} - 0.6$ | $V_{CC} - 0.26$ | - | V |
| | | $I_O = -12\text{ mA}$; $V_{CC} = 2.7\text{ V}$ | $V_{CC} - 0.5$ | $V_{CC} - 0.14$ | - | V |
| | | $I_O = -12\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | $V_{CC} - 0.6$ | $V_{CC} - 0.09$ | - | V |
| V_{OL} | LOW-level output voltage | $V_I = V_{IH}$ or V_{IL} | | | | |
| | | $I_O = 100\text{ }\mu\text{A}$; $V_{CC} = 2.3\text{ V}$ to 3.6 V | - | GND | 0.20 | V |
| | | $I_O = 6\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | - | 0.07 | 0.40 | V |
| | | $I_O = 12\text{ mA}$; $V_{CC} = 2.3\text{ V}$ | - | 0.15 | 0.70 | V |
| | | $I_O = 12\text{ mA}$; $V_{CC} = 2.7\text{ V}$ | - | 0.14 | 0.40 | V |
| | | $I_O = 24\text{ mA}$; $V_{CC} = 3.0\text{ V}$ | - | 0.27 | 0.55 | V |
| I_I | input leakage current | $V_{CC} = 2.3\text{ V}$ to 3.6 V ; $V_I = V_{CC}$ or GND | - | 0.1 | 5 | μA |
| I_{OZ} | OFF-state output current | $V_{CC} = 2.3\text{ V}$ to 3.6 V ; $V_I = V_{IH}$ or V_{IL} ; $V_O = V_{CC}$ or GND | - | 0.1 | 10 | μA |
| I_{CC} | supply current | $V_{CC} = 2.3\text{ V}$ to 3.6 V ; $V_I = V_{CC}$ or GND; $I_O = 0\text{ A}$ | - | 0.2 | 40 | μA |
| ΔI_{CC} | additional supply current | $V_{CC} = 2.3\text{ V}$ to 3.6 V ; $V_I = V_{CC} - 0.6\text{ V}$; $I_O = 0\text{ A}$ | - | 150 | 750 | μA |
| I_{BHL} | bus hold LOW current | $V_{CC} = 2.3\text{ V}$; $V_I = 0.7\text{ V}$ | 45 | - | - | μA |
| | | $V_{CC} = 3.0\text{ V}$; $V_I = 0.8\text{ V}$ | 75 | 150 | - | μA |
| I_{BHH} | bus hold HIGH current | $V_{CC} = 2.3\text{ V}$; $V_I = 1.7\text{ V}$ | -45 | - | - | μA |
| | | $V_{CC} = 3.0\text{ V}$; $V_I = 2.0\text{ V}$ | -75 | -175 | - | μA |
| I_{BHLO} | bus hold LOW overdrive current | $V_{CC} = 3.6\text{ V}$ | 500 | - | - | μA |
| I_{BHHO} | bus hold HIGH overdrive current | $V_{CC} = 3.6\text{ V}$ | -500 | - | - | μA |
| C_I | input capacitance | | - | 5.0 | - | pF |

[1] All typical values are measured at $T_{amb} = 25\text{ °C}$.

10. Dynamic characteristics

Table 7. Dynamic characteristics

At recommended operating conditions; voltages are referenced to GND (ground = 0 V); for test circuit see Fig. 10;
 $T_{amb} = -40\text{ °C to }+85\text{ °C}$

| Symbol | Parameter | Conditions | Min | Typ[1] | Max | Unit |
|-----------|-------------------------------|--|-----|--------|-----|------|
| t_{pd} | propagation delay | nDn to nQn; see Fig. 6 [2] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 2.5 | 5.0 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 1.0 | 2.6 | 4.7 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 2.4 | 3.9 | ns |
| | | nLE to nQn; see Fig. 7 | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 2.5 | 5.6 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 1.0 | 2.6 | 5.1 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 2.4 | 4.3 | ns |
| t_{en} | enable time | nOE to nQn; see Fig. 9 [3] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.0 | 2.7 | 6.2 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 1.0 | 3.1 | 6.0 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 2.3 | 4.9 | ns |
| t_{dis} | disable time | nOE to nQn; see Fig. 9 [4] | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.1 | 2.2 | 5.3 | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 1.3 | 3.1 | 4.3 | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.3 | 2.9 | 4.1 | ns |
| t_{su} | set-up time | nDn to nLE; see Fig. 8 | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.3 | 0.1 | - | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 1.1 | 0.1 | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.0 | 0.6 | - | ns |
| t_h | hold time | nDn to nLE; see Fig. 8 | | | | |
| | | $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ | 1.4 | 0.3 | - | ns |
| | | $V_{CC} = 2.7\text{ V}$ | 1.7 | 0.2 | - | ns |
| | | $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ | 1.4 | 0.2 | - | ns |
| t_W | pulse width | nLE HIGH; $V_{CC} = 2.3\text{ V to }3.6\text{ V}$; see Fig. 7 | 3.3 | 1.5 | - | ns |
| C_{PD} | power dissipation capacitance | per latch; $V_I = \text{GND to }V_{CC}$ [5] | | | | |
| | | outputs enabled | - | 19 | - | pF |
| | | outputs disabled | - | 3 | - | pF |

[1] Typical values are measured at $T_{amb} = 25\text{ °C}$

Typical values for $V_{CC} = 2.3\text{ V to }2.7\text{ V}$ are measured at $V_{CC} = 2.5\text{ V}$.

Typical values for $V_{CC} = 3.0\text{ V to }3.6\text{ V}$ are measured at $V_{CC} = 3.3\text{ V}$.

[2] t_{pd} is the same as t_{PLH} and t_{PHL} .

[3] t_{en} is the same as t_{PZL} and t_{PZH} .

[4] t_{dis} is the same as t_{PLZ} and t_{PHZ} .

[5] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

$P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \sum (C_L \times V_{CC}^2 \times f_o)$ where:

f_i = input frequency in MHz;

f_o = output frequency in MHz;

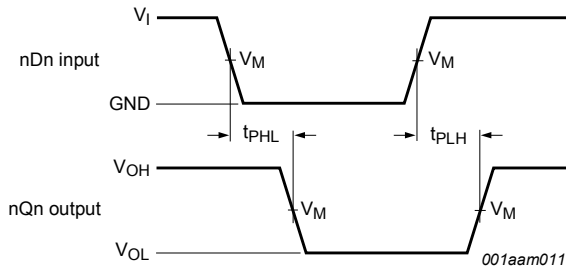
C_L = output load capacitance in pF;

V_{CC} = supply voltage in Volts;

N = total load switching outputs;

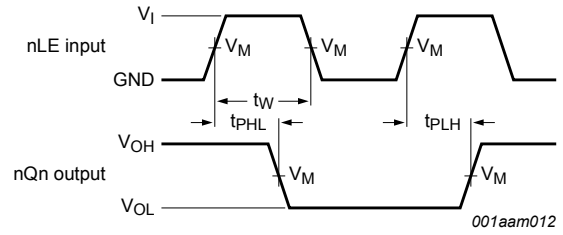
$\sum (C_L \times V_{CC}^2 \times f_o)$ = sum of outputs.

10.1. Waveforms and test circuit



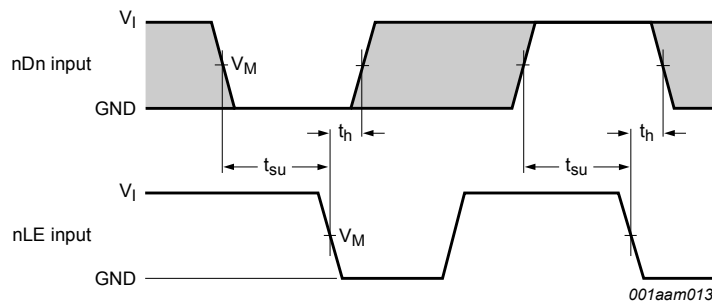
Measurement points are given in [Table 8](#). V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 6. Input (nDn) to output (nQn) propagation delays



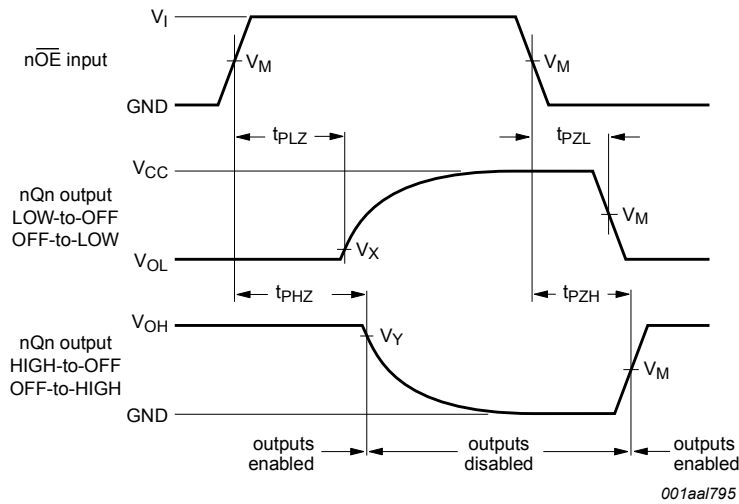
Measurement points are given in [Table 8](#). V_{OL} and V_{OH} are typical voltage output levels that occur with the output load.

Fig. 7. Latch enable input (nLE) to data output (nQn) propagation delays and pulse width (nLE)



Measurement points are given in [Table 8](#). The shaded areas indicate when the input is permitted to change for predictable output performance.

Fig. 8. Data setup and hold times for input (nDn) to input (nLE)



Measurement points are given in [Table 8](#). V_{OL} and V_{OH} are typical output levels that occur with the output load.

Fig. 9. 3-State enable and disable times

Table 8. Measurement points

| Input | | | Output | | |
|-----------------|-----------------|--------------------|--------------------|--------------------------|--------------------------|
| V _{CC} | V _I | V _M | V _M | V _x | V _y |
| < 2.3 V | V _{CC} | 0.5V _{CC} | 0.5V _{CC} | V _{OL} + 0.15 V | V _{OH} - 0.15 V |
| 2.3 V to 2.7 V | V _{CC} | 0.5V _{CC} | 0.5V _{CC} | V _{OL} + 0.15 V | V _{OH} - 0.15 V |
| 2.7 V | 2.7 V | 1.5 V | 1.5 V | V _{OL} + 0.3 V | V _{OH} - 0.3 V |
| 3.0 V to 3.6 V | 2.7 V | 1.5 V | 1.5 V | V _{OL} + 0.3 V | V _{OH} - 0.3 V |

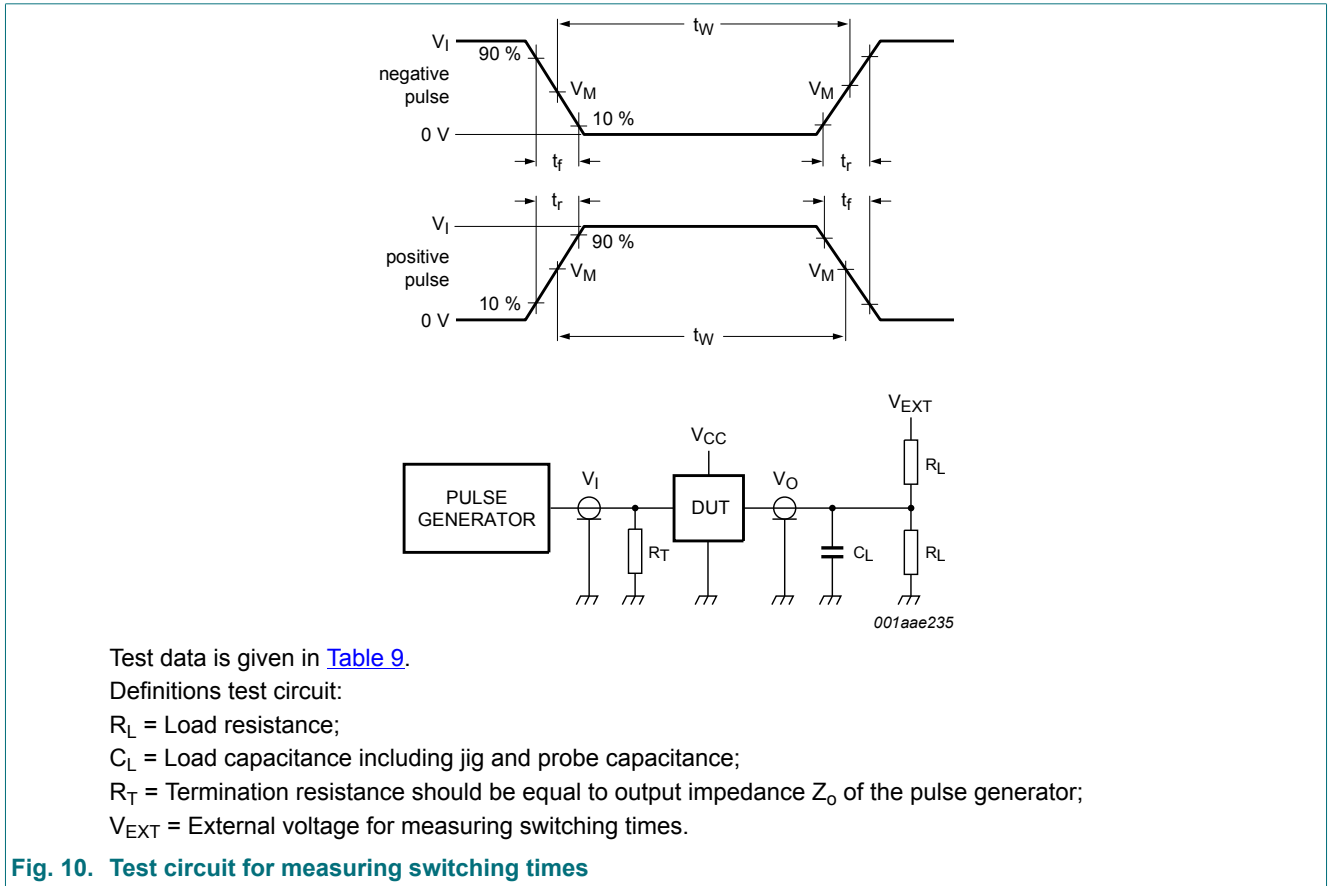


Fig. 10. Test circuit for measuring switching times

Table 9. Test data

| Input | | | Load | | V _{EXT} | | |
|-----------------|-----------------|---------------------------------|----------------|----------------|-------------------------------------|-------------------------------------|-------------------------------------|
| V _{CC} | V _I | t _r , t _f | R _L | C _L | t _{PHZ} , t _{PZH} | t _{PLZ} , t _{PZL} | t _{PLH} , t _{PHL} |
| < 2.3 V | V _{CC} | ≤ 2.0 ns | 500 Ω | 30 pF | GND | 2 × V _{CC} | open |
| 2.3 V to 2.7 V | V _{CC} | ≤ 2.0 ns | 500 Ω | 30 pF | GND | 2 × V _{CC} | open |
| 2.7 V | 2.7 V | ≤ 2.5 ns | 500 Ω | 50 pF | GND | 2 × V _{CC} | open |
| 3.0 V to 3.6 V | 2.7 V | ≤ 2.5 ns | 500 Ω | 50 pF | GND | 2 × V _{CC} | open |

11. Package outline

TSSOP56: plastic thin shrink small outline package; 56 leads; body width 6.1 mm

SOT364-1

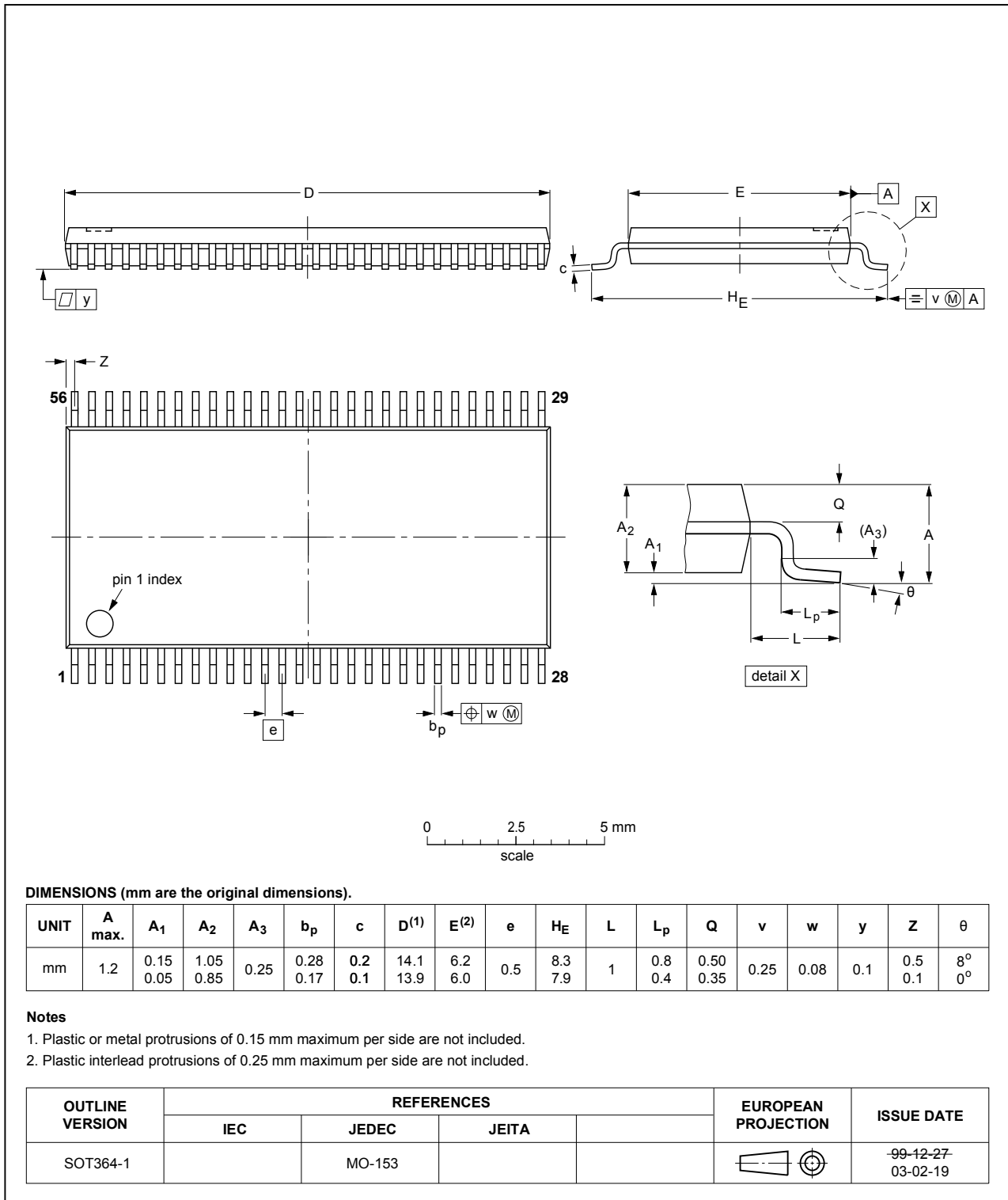


Fig. 11. Package outline SOT364-1 (TSSOP56)

12. Abbreviations

Table 10. Abbreviations

| Acronym | Description |
|---------|---|
| CDM | Charged Device Model |
| CMOS | Complementary Metal-Oxide Semiconductor |
| DUT | Device Under Test |
| ESD | ElectroStatic Discharge |
| HBM | Human Body Model |
| TTL | Transistor-Transistor Logic |

13. Revision history

Table 11. Revision history

| Document ID | Release date | Data sheet status | Change notice | Supersedes |
|------------------|---|-----------------------|---------------|------------------|
| 74ALVCH16841 v.3 | 20180912 | Product data sheet | - | 74ALVCH16841 v.2 |
| Modifications: | <ul style="list-style-type: none"> The format of this data sheet has been redesigned to comply with the identity guidelines of Nexperia. Legal texts have been adapted to the new company name where appropriate. | | | |
| 74ALVCH16841 v.2 | 19980727 | Product specification | - | 74ALVCH16841 v.1 |
| 74ALVCH16841 v.1 | 19980727 | Product specification | - | |

14. Legal information

Data sheet status

| Document status [1][2] | Product status [3] | Definition |
|--------------------------------|--------------------|---|
| Objective [short] data sheet | Development | This document contains data from the objective specification for product development. |
| Preliminary [short] data sheet | Qualification | This document contains data from the preliminary specification. |
| Product [short] data sheet | Production | This document contains the product specification. |

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